

Description

The IRF1407PBF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a

 $\label{eq:Battery protection or in other Switching application.}$



TO-220

General Features

 $V_{DS} = 120V I_D = 120A$

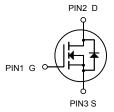
 $R_{DS(ON)} < 7.5 m\Omega$ @ V_{GS} =10V

Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
IRF1407PBF	TO-220	HXY MOSFET	50

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	120	V	
Vgs	Gate-Source Voltage	Gate-Source Voltage ±20		
ID	Continuous Drain CurrentTC=25 °C	120	А	
Ірм	PuledDrainCurrentnote1	320	А	
EAS	Single Pulse Avalanche Energy ³	326	mJ	
P _D @T _C =25°C	Total Power Dissipation ⁴	119	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
R ₀ JA	Thermal Resistance Junction-Ambient ¹	52	°C/W	
Rejc	Thermal Resistance Junction-Ambient ¹	1.05	°C/W	



Electrical Characteristics: (T_C=25 ℃ unless otherwise noted)

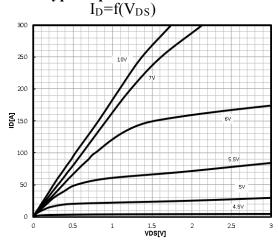
Symbol	Domomotor	Test Conditions	Value			T I:4 =	
	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_{D}=250\mu A$	120		1	V	
I_{DSS}	Drain to Source Leakage Current	$V_{DS} = 120V, V_{GS} = 0V$			1	μΑ	
I _{GSS(F)}	Gate to Source Forward Leakage	$V_{GS} = +20V$			100	nA	
$I_{GSS(R)}$	Gate to Source Reverse Leakage V _{GS} =-20V				-100	nA	
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{D}=250\mu A$	2.5	3	3.5	V	
R _{DS(ON)}	Drain-to-Source On- Resistance	$V_{GS}=10V, I_{D}=20A$		6	7.5	mΩ	
Ciss	Input Capacitance			3614			
Coss	Output Capacitance	$V_{GS} = 0V$		423		pF	
Crss	Reverse Transfer Capacitance	$ \begin{vmatrix} V_{DS} = 60V \\ f = 1.0MHz \end{vmatrix} $		12		P.	
R_g	Gate resistance			0.84		Ω	
t _{d(ON)}	Turn-on Delay Time	$I_D = 20A$		20		ns	
tr	Rise Time	$V_{DS} = 60V$		65			
$t_{d(OFF)}$	Turn-Off Delay Time	$V_{GS} = 10V$		32		ns	
t_{f}	Fall Time	$R_G = 5\Omega$		49			
Q_g	Total Gate Charge	$V_{GS} = 0 \sim 10V$		60.8	-		
Q_{gs}	Gate Source Charge	$V_{DS} = 60V$		18.8		nC	
Q_{gd}	Gate Drain Charge	$I_D = 20A$		14.7			
I_S	Diode Forward Current	$T_C = 25 ^{\circ}C$			120	A	
V_{SD}	Diode Forward Voltage	$I_S=20A$, $V_{GS}=0V$		0.83	1.2	V	
t_{rr}	Reverse Recovery time	$I_S=40A$,		60		ns	
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$		109		nC	

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature ^{a2}: VDD=60V, L=0.5mH, Rg=25 Ω , Starting TJ=25 °C

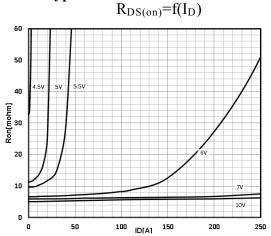


Typical Characteristics: (T_C=25 °C unless otherwise noted)

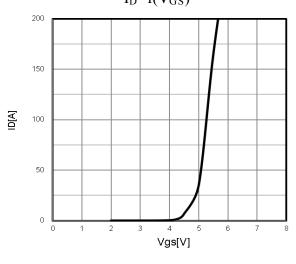
Typ. output characteristics



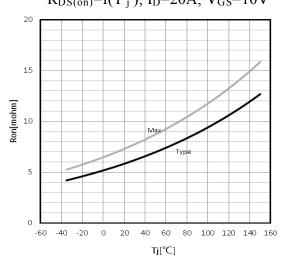
Typ. drain-source on resistance



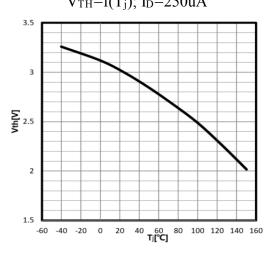
Typ. transfer characteristics $I_D=f(V_{GS})$



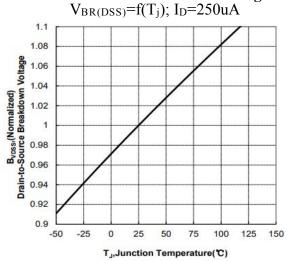
Drain-source on-state resistance R_{DS(on)}=f(T_i); I_D=20A; V_{GS}=10V



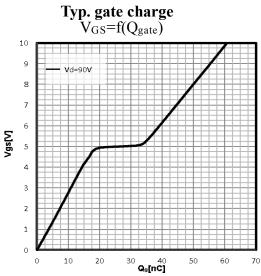
Gate Threshold Voltage V_{TH} = $f(T_j)$; I_D =250uA



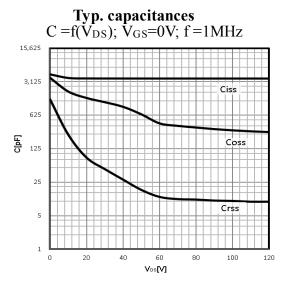
Drain-source breakdown voltage

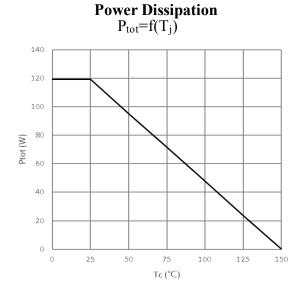


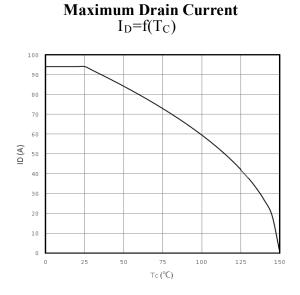


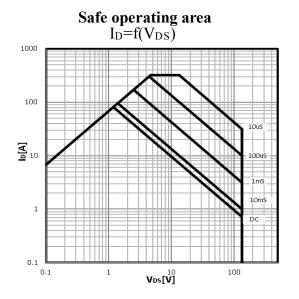


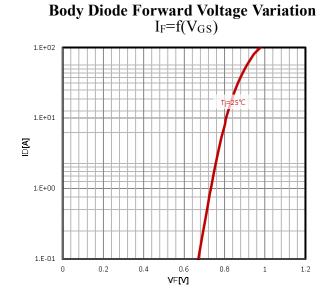
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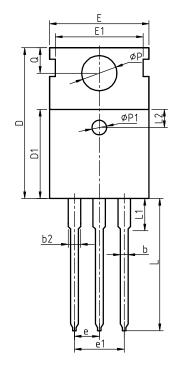


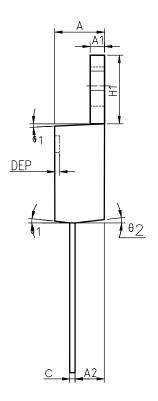




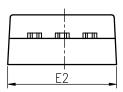


Package Information TO-220





COMMON DIMENSIONS



SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
Α	4.40	4.57	4. 70	0.173	0.180	0. 185
A1	1.27	1.30	1.33	0.050	0.051	0.052
A2	2.35	2.40	2.50	0.093	0.094	0.098
b	0.77	0.80	0.90	0.030	0.031	0.035
b2	1.17	1.27	1.36	0.046	0.050	0.054
С	0.48	0.50	0.56	0.019	0.020	0.022
D	15.40	15.60	15.80	0.606	0.614	0.622
D1	9.00	9.10	9. 20	0.354	0.358	0.362
DEP	0.05	0.10	0.20	0.002	0.004	0.008
E	9.80	10.00	10.20	0.386	0.394	0.402
E1	-	8.70	-	-	0.343	-
E2	9.80	10.00	10.20	0.386	0.394	0.402
е		2.54	BSC		0.100	BSC
e1		5.08	BSC		0.200	BSC
H1	6.40	6.50	6.60	0. 252	0. 256	0.260
L	12.75	13.50	13.65	0.502	0.531	0.537
L1	-	3. 10	3.30	-	0.122	0.130
L2		2.50	REF		0.098	REF
Р	3.50	3.60	3.63	0.138	0.142	0.143
P1	3.50	3.60	3.63	0.138	0.142	0.143
Q	2.73	2.80	2.87	0.107	0.110	0.113
θ 1	5°	7°	9°	5°	7°	9°
θ 2	1°	3°	5°	1°	3°	5°
θ 3	1°	3°	5°	1°	3°	5°



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